

FIG. 1A

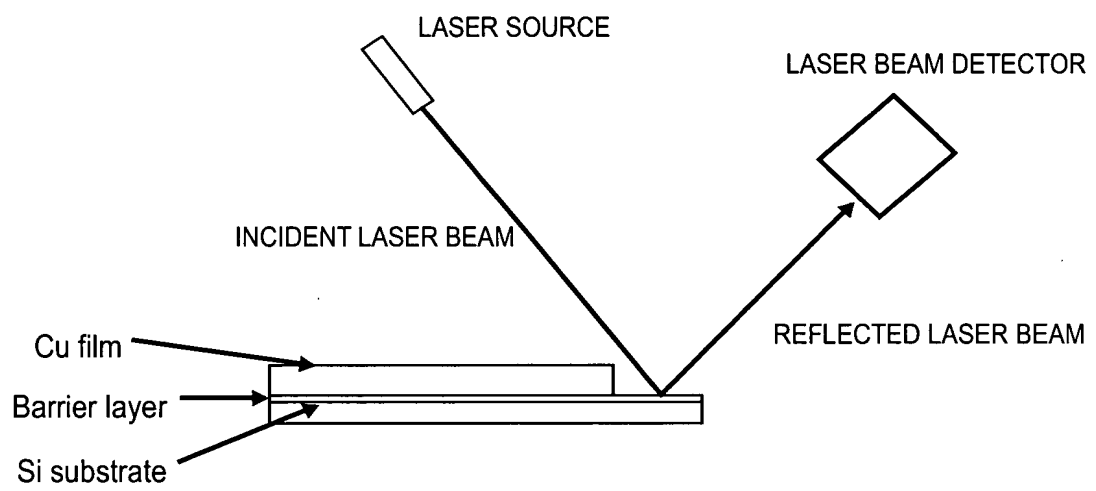
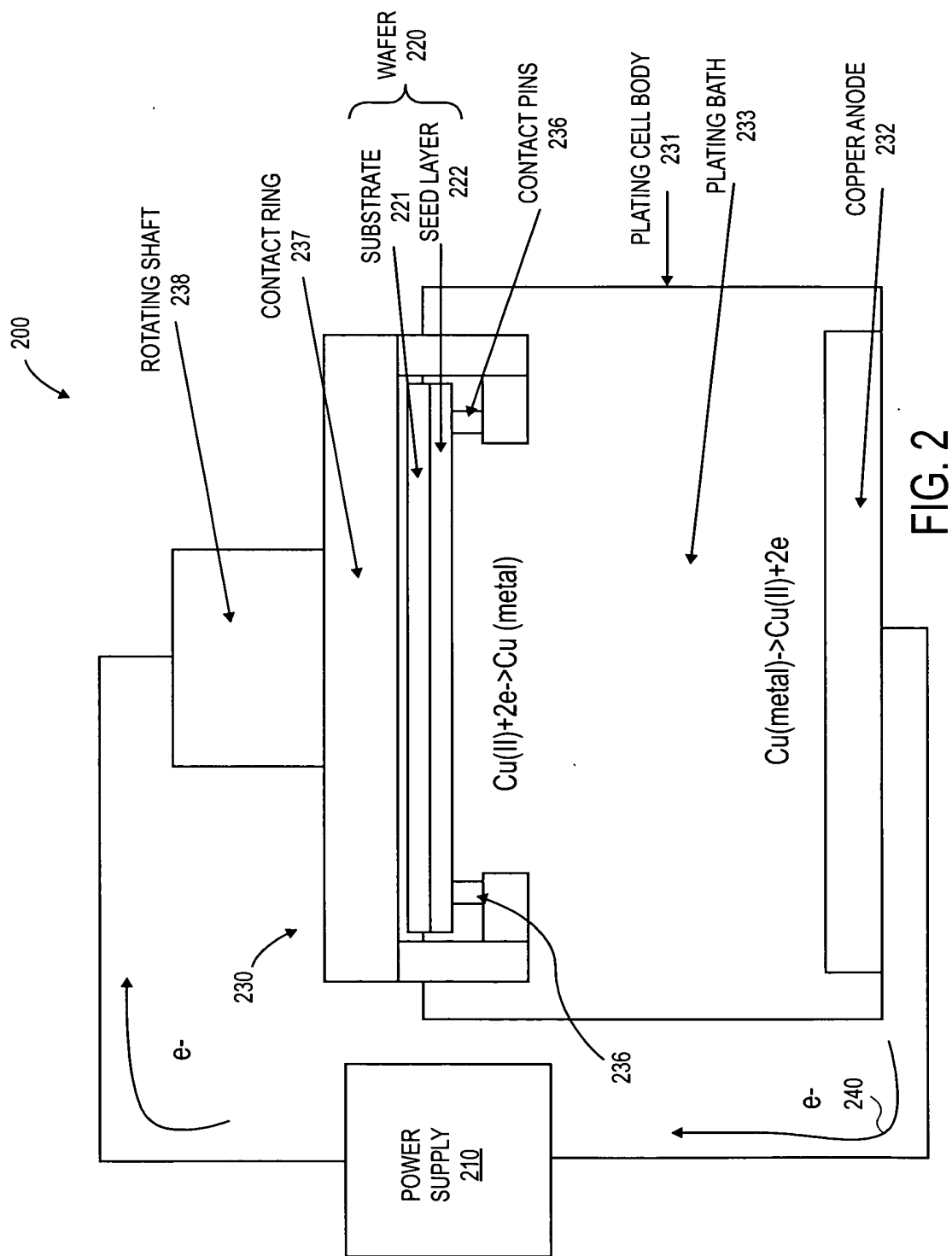


FIG. 1B



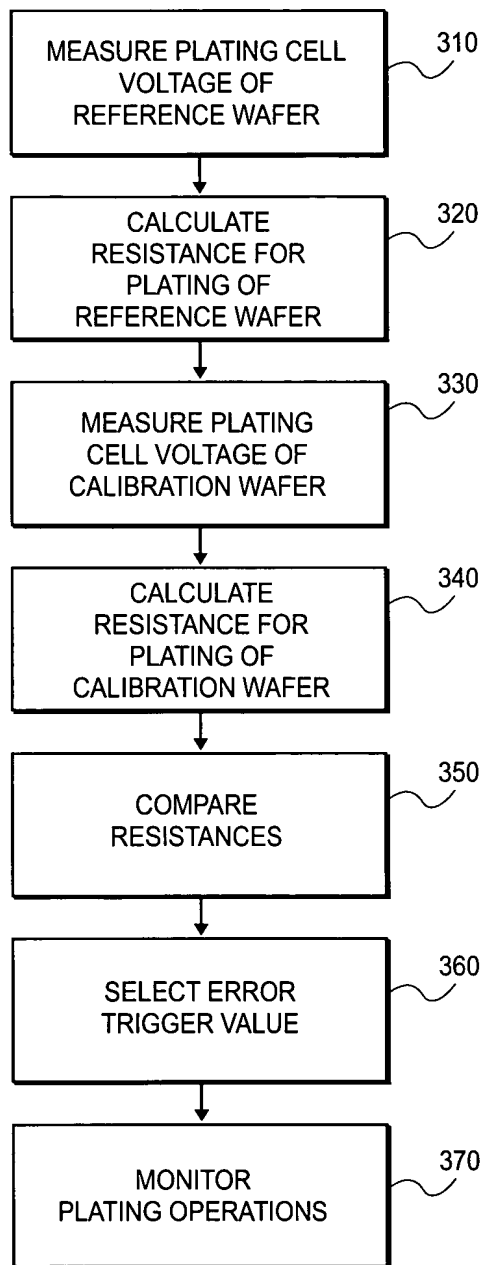


FIG. 3

400

PLATING CURRENT 410	CELL VOLTAGE REFERENCE WAFER 420	CELL VOLTAGE CALIBRATION WAFER 430	CELL VOLTAGE DIFFERENCE 440	RATIO 450
0.1	0.06957	0.10626	0.03669	0.527382
0.2	0.13914	0.21252	0.07338	0.527382
0.5	0.34785	0.5313	0.18345	0.527382
1	0.6957	1.0626	0.3669	0.527382
2	1.3914	2.1252	0.7338	0.527382
5	3.4785	5.313	1.8345	0.527382
10	6.957	10.626	3.669	0.527382
15	10.4355	15.939	5.5035	0.527382

FIG. 4

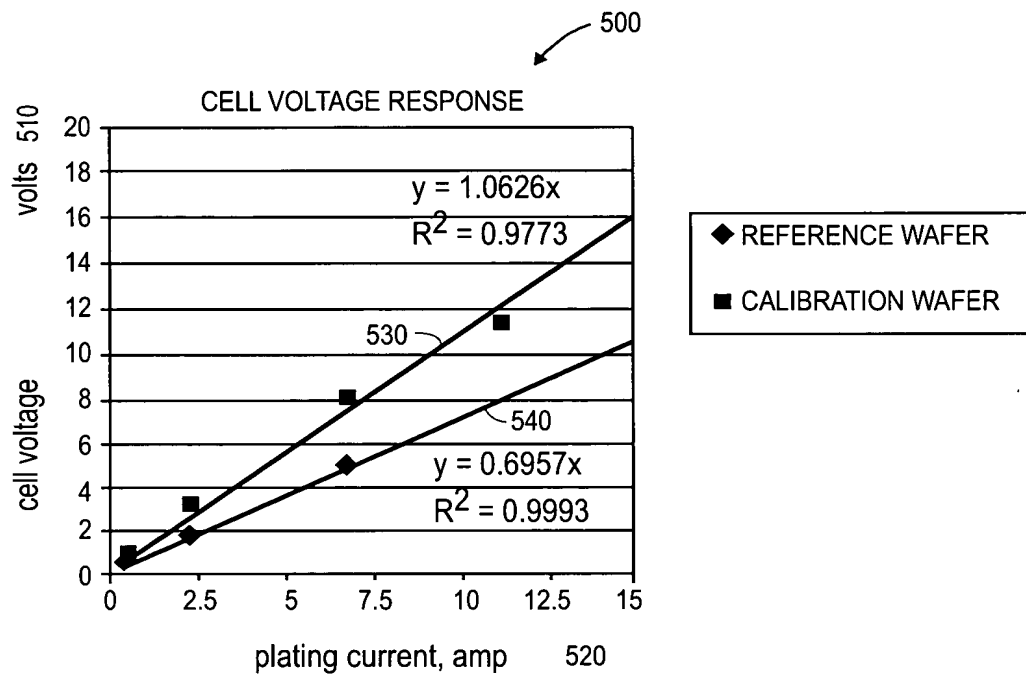


FIG. 5

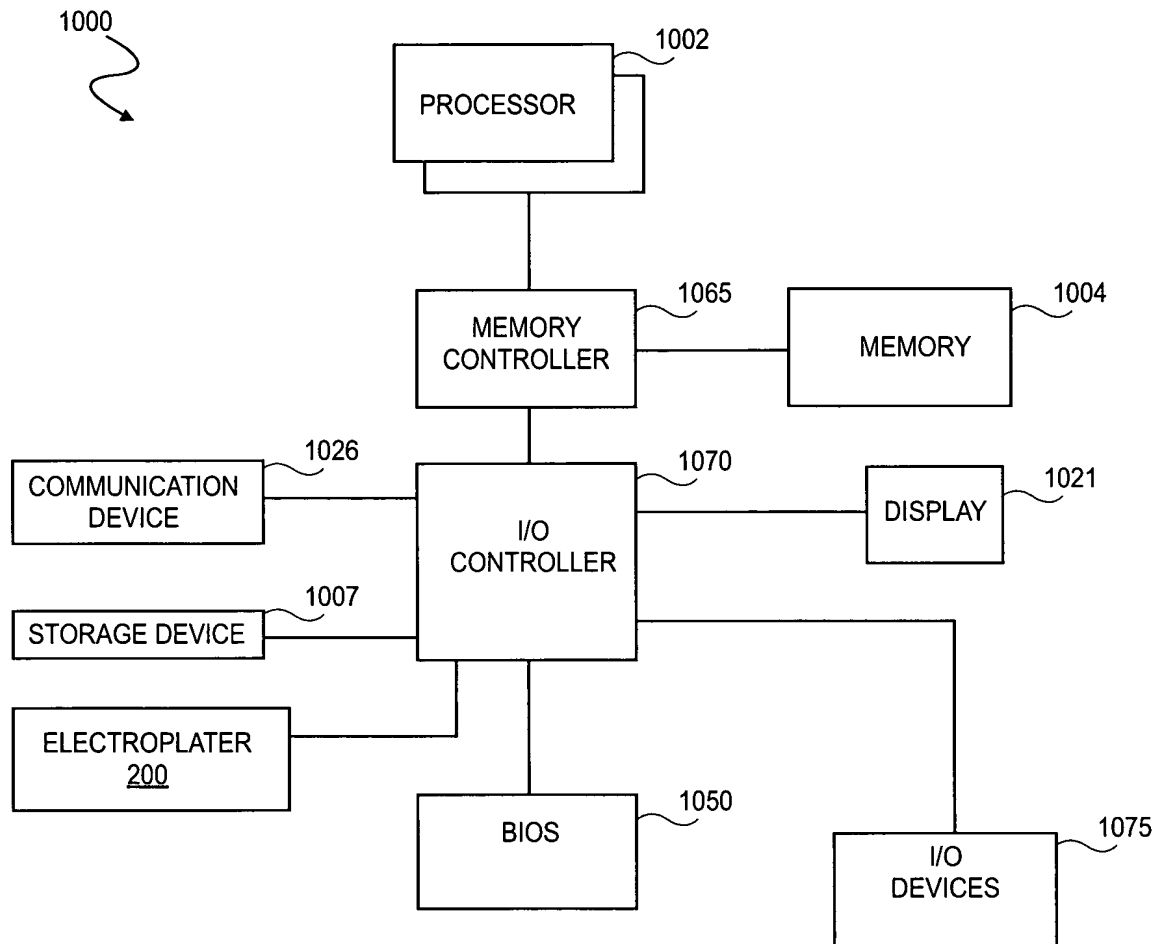


FIG. 6